National Semiconductor

PRELIMINARY
March 1999

LMX2370/LMX2371/LMX2372 PLLatinum™ Dual Frequency Synthesizer for RF Personal Communications

LMX2370 2.5 GHz/1.2 GHz
LMX2371 2.0 GHz/1.2 GHz
LMX2372 1.2 GHz/1.2 GHz

General Description

The LMX237X family of monolithic, integrated dual frequency synthesizers, including prescalers, is designed to be used as a first and second local oscillator for dual mode or dual conversion transceivers. It is fabricated using National's 0.5u ABiCV silicon BiCMOS process. The LMX237X contains two dual modulus prescalers. A 32/33 or a 16/17 prescaler can be selected for the 2.5 GHz and 2.0 GHz RF synthesizers with the 16/17 prescaler rated for input frequencies below 1.2 GHz. A 16/17 or an 8/9 prescaler can be selected for the 1.2 GHz RF synthesizers with the 8/9 prescaler rated for input frequencies below 550 MHz. Using a digital phase locked loop technique, the LMX237X can generate very stable, low noise control signals for UHF and VHF voltage controlled oscillators (VCO's). Serial data is transferred into the LMX237X via a 1.8V three wire interface (Data, Enable, Clock) compatible with low voltage baseband processors. Supply voltage can range from 2.7V to 5.5V. The LMX237X family features very low current consumption typically: LMX2370 - 6.0 mA @ 3V, LMX2371 - 5.0 mA @ 3V, LMX2372 - 4.0 mA @ 3V.

The LMX237X are available in a 24-pad chip scale (CSP) or a 20-pin TSSOP surface mount plastic package.

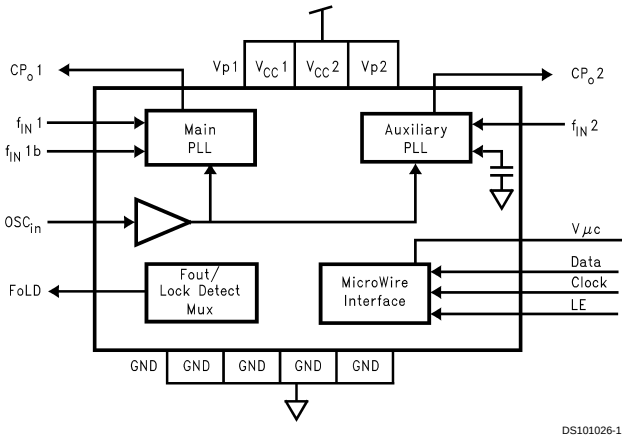
Features

- 2.7V–5.5V operation
- Ultra low current consumption
- Low phase detector noise floor
- Low voltage MICROWIRE™ interface (1.8V up to V_{CC})
- Low prescaler values
  - 32/33 @ $f_{IN} \leq 2.5$ GHz
  - 16/17 @ $f_{IN} \leq 1.2$ GHz
  - 8/9 @ $f_{IN} \leq 550$ MHz
- Selectable charge pump current levels
- Selectable FastLock™ mode
- Enhanced ESD protection
- Small 24 pad chip scale package (3.5 x 4.5 x 1.0 mm)

Applications

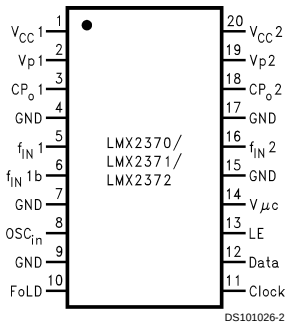
- Portable wireless communications (PCS/PCN, cordless)
- Dual mode cellular telephone systems
- Spread spectrum communication systems (CDMA)
- Cable TV tuners (CATV)

Functional Block Diagram



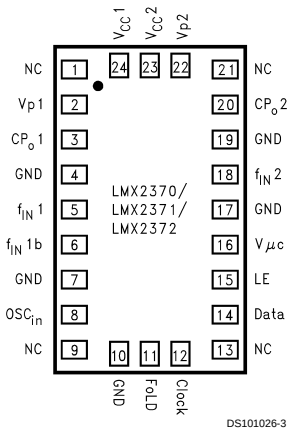
Connection Diagrams

TSSOP 20-Pin Package



Top View
Order Number LMX2370TM, LMX2370TMX, LMX2371TM, LMX2371TMX, LMX2372TM or LMX2372TMX
See NS Package Number MTC20

CSP 24-Pin Package



Top View
Order Number LMX2370SLBX, LMX2371SLBX or LMX2372SLBX
See NS Package Number SLB24A

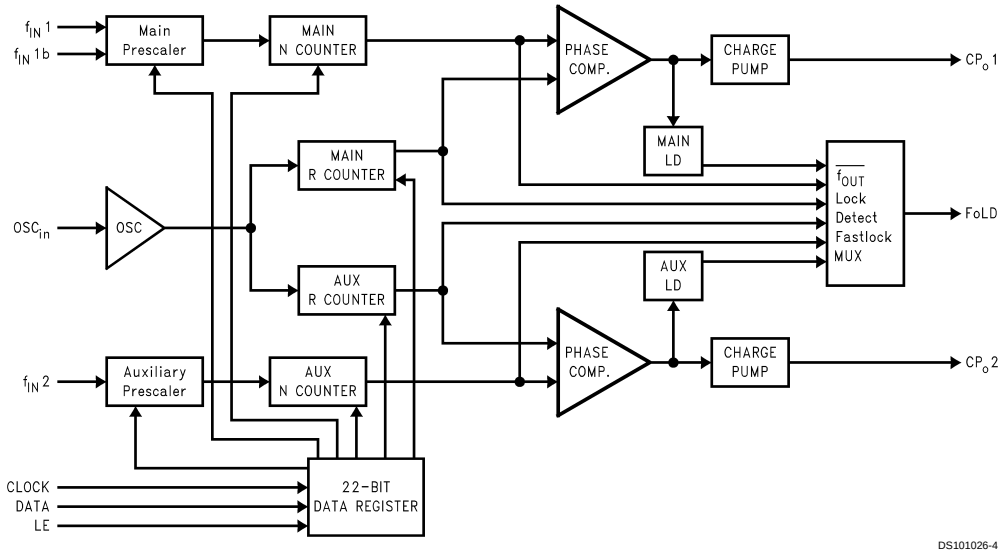
Pin Descriptions

Pin No.		Pin Name	I/O	Description
24-Pin CSP	20-Pin TSSOP			
24	1	$V_{CC}1$	—	Power supply voltage input for RF analog and RF digital circuits. Input may range from 2.7V to 5.5V. $V_{CC}1$ must equal $V_{CC}2$. Bypass capacitors should be placed as close as possible to this pin and be connected directly to the ground plane.
2	2	Vp1	—	Power supply for Main charge pump. Must be ≥ V_{CC}.
3	3	CP_o1	O	Internal Main charge pump output. For connection to a loop filter for driving the input of an external VCO.
4	4	GND	—	Ground for Main digital circuitry.
5	5	$f_{IN}1$	I	Main prescaler input. Small signal input from the VCO.
6	6	$f_{IN}1b$	I	Main prescaler complementary input. For single ended operation, a bypass capacitor should be placed as close as possible to this pin and be connected directly to the ground plane.
7	7	GND	—	Ground for Main analog circuitry.
8	8	OSC_{in}	I	Oscillator input. The input has a $V_{CC}/2$ input threshold and can be driven from an external CMOS or TTL logic gate.
10	9	GND	—	Ground for Aux digital, MICROWIRE, FoLD, and oscillator circuits.
11	10	Fo/LD	O	Multiplexed output of the Main/Aux programmable or reference dividers, Main/Auxiliary lock detect signals and Fastlock mode. CMOS output *(see Programmable Modes in the Datasheet).*
12	11	Clock	I	High impedance CMOS Clock input. Data for the various counters is clocked in on the rising edge, into the 22-bit shift register.
14	12	Data	I	Binary serial data input. Data entered MSB first. The last two bits are the control bits. High impedance CMOS input.
15	13	LE	I	Load enable. High impedance CMOS input. When LE goes HIGH, data stored in the shift registers is loaded into one of the 4 appropriate latches (control bit dependent).

Pin Descriptions (Continued)

Pin No.		Pin Name	I/O	Description
24-Pin CSP	20-Pin TSSOP			
16	14	Vμc	—	Power supply for MICROWIRE circuitry. Must be ≤ V_{CC}. Typically connected to same supply level as μprocessor or baseband controller to enable programming at low voltages.
17	15	GND	—	Ground for Aux analog circuitry.
18	16	$f_{IN}2$	I	Auxiliary prescaler input. Small signal input from the VCO.
19	17	GND	—	Ground for Aux digital, MICROWIRE, FoLD, and oscillator.
20	18	CP_o2	O	Aux internal charge pump output. For connection to a loop filter for driving the input of an external VCO.
22	19	Vp2	—	Power supply for Aux charge pump. Must be ≥ V_{CC}.
23	20	$V_{CC}2$	—	Power supply voltage input for Aux analog, Aux digital, FoLD, and oscillator circuits. Input may range from 2.7V to 5.5V. $V_{CC}2$ must equal $V_{CC}1$. Bypass capacitors should be placed as close as possible to this pin and be connected directly to the ground plane.
1, 9, 13, 21	—	NC	—	No Connect

Block Diagram



Absolute Maximum Ratings (Notes 1, 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Power Supply Voltage	
$V_{CC}1$	−0.3V to 6.5V
$V_{CC}2$	−0.3V to 6.5V
Vp1	−0.3V to 6.5V
Vp2	−0.3V to 6.5V
Vμc	−0.3V to 6.5V
Voltage on any pin with GND = 0V (V_I)	−0.3V to V_{CC} +0.3V
Storage Temperature Range (T_S)	−65˚C to +150˚C
Lead Temperature (solder, 4 sec.) (T_L)	+260˚C
ESD - Human Body Model (Note 2)	TBD

Recommended Operating Conditions (Note 3)

Power Supply Voltage	
$V_{CC}1$	2.7V to 5.5V
$V_{CC}2$	2.7V to 5.5V
$V_{CC}1$–$V_{CC}2$	−0.2V to 0.2V
Vp1	V_{CC} to 5.5V
Vp2	V_{CC} to 5.5V
Vμc	1.72V to V_{CC}
Operating Temperature (T_A)	−40˚C to +85˚C

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed.

Note 2: This device is a high performance RF integrated circuit and is ESD sensitive. Handling and assembly of this device should only be done at ESD free workstations.

Note 3: V_{CC} is defined as $V_{CC} = V_{CC}1 = V_{CC}2$.

Electrical Characteristics (V_{CC} = Vp = Vμc = 3.0V; −40˚C < T_A < 85˚C except as specified).

GENERAL				Value			Unit
Symbol	**Parameter**		**Conditions**	**Min**	**Typ**	**Max**	
I_{CC}	Power Supply Current	LMX2370	Main = On, Aux = On		6	8.5	mA
		LMX2371	Main = On, Aux = On		5	7.5	mA
		LMX2372	Main = On, Aux = On		4	6.0	mA
		LMX2370 /71/72	Aux Only		2	3.25	mA
$I_{CC\text{-}PWDN}$	Power Down Current		EN_Main, EN_Aux = 0		15	50	μA
$f_{IN}1$	Main PLL Operating Frequency	LMX2370	P = 32/33	1.2		2.5	GHz
			P = 16/17	45		1200	MHz
		LMX2371	P = 32/33	1.2		2.0	GHz
			P = 16/17	45		1200	MHz
		LMX2372	P = 16/17	45		1200	MHz
			P = 8/9	45		550	MHz
$f_{IN}2$	Auxiliary PLL Operating Frequency		P = 16/17	45		1200	MHz
			P = 8/9	45		550	MHz
Zf_{IN} Main	Main PLL Input Impedance		RF On, f_{IN} = 1800 MHz		TBD		Ω
			RF Off, f_{IN} = 1800 MHz		TBD		Ω
Zf_{IN} Aux	Aux Input Impedance		f_{IN} = 120 MHz		TBD		Ω
fϕ	Phase Detector Frequency					10	MHz
$Pf_{IN}1$, $Pf_{IN}2$	RF Input Sensitivity		2.7 ≤ V_{CC} ≤ 3.6V	−15		0	dBm
			3.6 ≤ V_{CC} ≤ 5.5V	−10		0	dBm

OSCILLATOR INPUT			Value			Unit
Symbol	**Parameter**	**Conditions**	**Min**	**Typ**	**Max**	
OSC_{in}	Reference Oscillator Input Operating Frequency		2		50	MHz
Z_{IN} OSC	OSC Input Impedance	OSC On, Freq = 10 MHz		TBD		kΩ
		OSC Off, Freq = 10 MHz		TBD		kΩ
V_{OSC}	Oscillator Input Sensitivity	OSC_{in}	0.5		V_{CC}	V_{PP}
I_{IH}	OSC_{in} Input Current	V_{IH} = V_{CC} = 5.5V			100	μA
I_{IL}	OSC_{in} Input Current	V_{IL} = 0, V_{CC} = 5.5V	−100			μA

Electrical Characteristics (V_{CC} = Vp = Vμc = 3.0V; −40˚C < T_A < 85˚C except as specified). (Continued)

CHARGE PUMP			Value			Unit
Symbol	Parameter	Conditions	Min	Typ	Max	
$ICP_{o\text{-}source}$	Main and Auxiliary Charge Pump Output Current (Note 4)	VCP_o = Vp/2, **ICP_o_4X** = 0		1.0		mA
$ICP_{o\text{-}sink}$		VCP_o = Vp/2, **ICP_o_4X** = 0		−1.0		mA
$ICP_{o\text{-}source}$		VCP_o = Vp/2, **ICP_o_4X** = 1		4.0		mA
$ICP_{o\text{-}sink}$		VCP_o = Vp/2, **ICP_o_4X** = 1		−4.0		mA
$ICP_{o\text{-}TRI}$	Charge Pump TRI-STATE® Current	0.5 ≤ VCP_o ≤ Vp − 0.5, −40˚C < T_A < 85˚C	−2.5	0.1	2.5	nA
$ICP_{o\text{-}sink}$ vs $ICP_{o\text{-}source}$	CP Sink vs Source Mismatch	VCP_o = Vp/2, T_A = 25˚C		3	10	%
ICP_o vs VCP_o	CP Current vs Voltage	0.5 ≤ VCP_o ≤ Vp − 0.5, T_A = 25˚C		8	15	%
ICP_o vs T_A	CP Current vs Temperature	VCP_o = Vp/2, −40˚C < T_A < 85˚C		8		%

DIGITAL INTERFACE (DATA, CLOCK, LE)			Value			Unit
Symbol	Parameter	Conditions	Min	Typ	Max	
V_{IH}	High-Level Input Voltage	Vμc = 1.72V to 5.5V	0.8 Vμc			V
V_{IL}	Low-Level Input Voltage	Vμc = 1.72V to 5.5V			0.2 Vμc	V
I_{IH}	High-Level Input Current	V_{IH} = Vμc = 5.5V	−1.0		1.0	μA
I_{IL}	Low-Level Input Current	V_{IL} = 0, Vμc = 5.5V	−1.0		1.0	μA
V_{OL}	Low-Level Output Current	I_{OL} = 1.0 mA, V_{EXT} = 1.8V (Note 5)		0.1	0.4	V

MICROWIRE TIMING			Value			Unit
Symbol	Parameter	Conditions	Min	Typ	Max	
t_{CS}	Data to Clock Setup Time	See Data Input Timing	50			ns
t_{CH}	Data to Clock Hold Time	See Data Input Timing	20			ns
t_{CWH}	Clock Pulse Width High	See Data Input Timing	50			ns
t_{CWL}	Clock Pulse Width Low	See Data Input Timing	50			ns
t_{ES}	Clock to Load Enable Setup Time	See Data Input Timing	50			ns
t_{EW}	Load Enable Pulse Width	See Data Input Timing	50			ns

Note 4: Main and Auxiliary Charge Pump magnitude are controlled by Main_ICP_o_4X and Aux_ICP_o_4X bits respectively.

Note 5: Lock Detect open drain output only pulled up to V_{EXT}. Typically V_{EXT} = V_{CC}.

1.0 Functional Description

The basic phase-lock-loop (PLL) configuration consists of a high-stability crystal reference oscillator, a frequency synthesizer such as the National Semiconductor LMX2370/2371/2372, a voltage controlled oscillator (VCO), and a passive loop filter. The frequency synthesizer includes a phase detector, a current mode charge pump, as well as programmable reference [R] and feedback [N] frequency dividers. The VCO frequency is established by dividing the crystal reference signal down via the R-counter to obtain a comparison reference frequency. This reference signal (f_R) is then presented to the input of a phase/frequency detector and compared with the feedback signal (f_N), which is obtained by dividing the VCO frequency down by way of the N-counter. The phase/frequency detector's current source output pumps charge into the loop filter, which then integrates into the VCO's control voltage. The function of the phase/frequency comparator is to adjust the control voltage presented to the VCO until the feedback signal frequency and phase match that of the reference signal. When this "Phase-Locked" condition exists, the VCO frequency will be N times that of the comparison frequency, where N is the integer divide ratio.

1.1 REFERENCE OSCILLATOR INPUT

The reference oscillator frequency for the Main and Auxiliary PLLs is provided from the external reference through the OSC_{in} pin. OSC_{in} can operate up to 50 MHz with input sensitivity of 0.5 V_{PP}. The OSC_{in} pin drives both the Main R-counter and the Auxiliary R-counter. The input has a V_{CC}/2 input threshold that can be driven from an external CMOS or TTL logic gate. Typically, the OSC_{in} is connected to the output of a crystal oscillator.

1.2 REFERENCE DIVIDERS (R-COUNTERS)

The Main and Auxiliary R-counters are both clocked through the oscillator block in common. The maximum frequency is 50 MHz. Both R-counters are CMOS design and 15-bit in length with programmable divider ratio from 2 to 32,767.

1.0 Functional Description (Continued)

1.3 PRESCALERS

The complimentary f_{IN} and f_{INB} inputs drive a differential-pair amplifier which feeds to the respective prescaler. The Main PLL complementary $f_{IN}1$ and $f_{IN}1b$ inputs can be driven differentially, or the negative input can be AC coupled to ground through an external capacitor for single ended configuration. The Auxiliary PLL has the complimentary input AC coupled to ground through an internal 10 pF capacitor. The Auxilllary PLL complimentary input is not brought out to a pin, and is intended for single ended configuration only. The LMX237X has a dual modulus prescaler with 2 selectable modulo. For PLL's rated at 2.5 GHz or 2.0 GHz a 32/33 or 16/17 prescaler is available. For PLL's rated at 1.2 GHz a 16/17 or 8/9 can be chosen. Both Main and Auxiliary prescalers' outputs drive the subsequent CMOS flip-flop chain comprising the programmable N feedback counters. The proper prescaler value must be chosen to in order not to exceed the maximum CMOS frequency. For $f_{IN} >$ 1.2 GHz, the 32/33 prescaler must be selected, similarly for $f_{IN} >$ 550 MHz, the prescaler value must be at least 16/17, and for $f_{IN} <$ 550 MHz, an 8/9 prescaler value is allowable.

1.4 FEEDBACK DIVIDERS (N-COUNTERS)

The Main and Auxiliary N-counters are clocked by the output of Main and Aux prescalers respectively. The N-counter is composed of a 13-bit integer divider and a 5-bit swallow counter. Selecting a 32/33 prescaler provides a minimum continuous divider range from 992 to 262,143 while selecting a 16/17 or 8/9 prescaler value allows for continuous divider values between and 240 to 131,087 and 56 to 65,559 respectively.

1.5 PHASE/FREQUENCY DETECTORS

The phase/frequency detectors are driven from their respective N- and R-counter outputs. The maximum frequency at the phase detector inputs is 10 MHz unless limited by the minimum continuous divide ratio of the dual-modulus prescaler. The phase detector output controls the charge pump. The polarity of the pump-up or pump-down control is programmed using **Main_PD_POL** or **Aux_PD_POL**, depending on whether Main or Auxiliary VCO characteristics is positive or negative. The phase detector also receives a feedback signal from the charge pump in order to eliminate dead zone.

1.6 CHARGE PUMPS

The phase detector's current source output pumps charge into an external loop filter, which then integrates into the VCO's control voltage. The charge pump steers the charge pump output CP_o to V_P (pump-up) or Ground (pump-down). When locked, CP_o is primarily in a TRI-STATE mode with small corrections. The charge pump output current magnitude can be selected as 1.0 mA or 4.0 mA by programming the **Main_ICP$_o$_4X** or **Aux_ICP$_o$_4X** bits.

1.7 MICROWIRE SERIAL INTERFACE

The programmable register set is accessed through the Microwire serial interface. The interface is comprised of three signal pins: clock, data and load enable (LE). The supply for the MICROWIRE circuitry is separate from the rest of the IC to allow for controller voltages down to 1.8V. Serial data is clocked into the 22-bit shift register upon the rising edge of clock. The MSB bit of data shifts first. The last two bits decode the internal register address. On the rising edge of LE, data stored in the shift register is loaded into one of the four latches according to the address bits. The synthesizer can be programmed even in power down state. A complete programming description is followed in Section 2.0.

1.8 MULTIFUNCTION OUTPUTS

The LMX2370/LMX2371/LMX2372 FoLD output pin can be configured as the FastLock output or CMOS programmed output, analog lock detects as well as showing the internal block status such as the counter outputs.

1.8.1 Lock Detect Output

An analog lock detect status generated from the phase detector is available on the Fo/LD output pin, if selected. The lock detect output goes high when the charge pump is inactive. It goes low when the charge pump is active during a comparison cycle. The lock detect signal output is an open drain configuration. When a PLL is in power down mode, the respective lock detect output is always high.

1.8.2 FastLock Outputs

When configured as FastLock mode, the current can be increased 4x while maintaining loop stability by synchronously switching a parallel loop filter resistor to ground, resulting in a $\sim$2x change in loop bandwidth. The zero gain crossover point of the open loop gain, or the loop bandwidth is effectively shifted up in frequency by a factor of $\sqrt{4} = 2$ during FastLock mode. For $\omega' = 2\omega$, the phase margin during FastLock will also remain constant. The charge pump current is programmed via MICROWIRE interface. When the charge pump circuit receives an input to deliver 4 times the normal current per unit phase error, an open drain NMOS on chip device (FoLD) switches in a second resistor element to ground. The user calculates the loop filter component values for the normal steady state considerations. The device configuration ensures that as long as a second resistor equal to the primary resistor value is wired in appropriately, the loop will lock faster without any additional stability considerations to account for.

1.9 POWER CONTROL

Each PLL is individually power controlled by device power-down (**PWDN**) bits. The **Main_PWDN** and **Aux_PWDN** bits determine the state of power control. Activation of any PLL power-down condition results in the disabling of the respective N-counter and de-biasing of its respective f_{IN} input (to a high impedance state). The R-counter functionality also becomes disabled under this condition.

1.0 Functional Description (Continued)

The reference oscillator input block is powered down when both Main_PWDN and Aux_PWDN bits are asserted. The OSC_{in} pin reverts to a high impedance state when this condition exists. Power down forces the respective charge pump and phase comparator logic to a TRI-STATE condition. During the power down condition, both N- and R-counters are held at reset. Upon powering up, the N-counter resumes counting in "close" alignment with the R-counter. The maximum error is at most one prescaler cycle. The MICROWIRE interface remains active and it is capable of loading and latching in data during all of the power down modes.

2.0 Programming Description

2.1 MICROWIRE INTERFACE

The LMX237X register set can be accessed through the MICROWIRE interface. A 22-bit shift register is used as a temporary register to indirectly program the on-chip registers. The shift register consists of a 20-bit DATA[19:0] field and a 2-bit ADDRESS[1:0] field as shown below. The address field is used to decode the internal register address. Data is clocked into the shift register in the direction from MSB to LSB, when the CLOCK signal goes high. On the rising edge of Load Enable (LE) signal, data stored in the shift register is loaded into the addressed latch.

MSB			LSB
DATA[19:0]		ADDRESS[1:0]	
21	2	1	0

2.1.1 Registers' Address Map

When Load Enable (LE) is transitioned high, data is transferred from the 22-bit shift register into the appropriate latch depending on the state of the ADDRESS[1:0] bits. A multiplexing circuit decodes these address bits and writes the data field to the corresponding internal register.

ADDRESS[1:0] FIELD		**REGISTER ADDRESSED**
0	0	Aux_R Register
0	1	Aux_N Register
1	0	Main_R Register
1	1	Main_N Register

2.0 Programming Description (Continued)

2.1.2 Registers' Truth Table

	Most Significant Bit					SHIFT REGISTER BIT LOCATION															Least Significant Bit	
	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	Data Field																				*Address Field*	
Aux_R	FoLD 1	FoLD 0	Aux_ CP_o- TRI	Aux_ CP_o- 4X	Aux_ PD_ POL	Aux_R_CNTR[14:0]															0	0
	Aux_ R19	Aux_ R18	Aux_ R17	Aux_ R16	Aux_ R15	Aux_ R14	Aux_ R13	Aux_ R12	Aux_ R11	Aux_ R10	Aux_ R9	Aux_ R8	Aux_ R7	Aux_ R6	Aux_ R5	Aux_ R4	Aux_ R3	Aux_ R2	Aux_ R1	Aux_ R0		
Aux_N	Aux_ PWDN	P_ Aux	Aux_B_CNTR[12:0]												Aux_A_CNTR[4:0]						0	1
	Aux_ N19	Aux_ N18	Aux_ N17	Aux_ N16	Aux_ N15	Aux_ N14	Aux_ N13	Aux_ N12	Aux_ N11	Aux_ N10	Aux_ N9	Aux_ N8	Aux_ N7	Aux_ N6	Aux_ N5	Aux_ N4	Aux_ N3	Aux_ N2	Aux_ N1	Aux_ N0		
Main_R	FoLD 3	FoLD 2	Main_ CP_o- TRI	Main_ CP_o- 4X	Main_ PD_ POL	Main_R_CNTR[14:0]															1	0
	Main_ R19	Main_ R18	Main_ R17	Main_ R16	Main_ R15	Main_ R14	Main_ R13	Main_ R12	Main_ R11	Main_ R10	Main_ R9	Main_ R8	Main_ R7	Main_ R6	Main_ R5	Main_ R4	Main_ R3	Main_ R2	Main_ R1	Main_ R0		
Main_N	Main_ PWDN	P_ Main	Main_B_CNTR[12:0]												Main_A_CNTR[4:0]						1	1
	Main_ N19	Main_ N18	Main_ N17	Main_ N16	Main_ N15	Main_ N14	Main_ N13	Main_ N12	Main_ N11	Main_ N10	Main_ N9	Main_ N8	Main_ N7	Main_ N6	Main_ N5	Main_ N4	Main_ N3	Main_ N2	Main_ N1	Main_ N0		

2.0 Programming Description (Continued)

2.2 PROGRAMMABLE REFERENCE DIVIDERS (Main and Aux R Counters)

2.2.1 Aux_R Register

If the ADDRESS[1:0] field is set to 0 0, data is transferred from the 22-bit shift register into the Aux_R register when Load Enable (LE) signal goes high. The Aux_R register sets the Aux PLL's 15-bit R-counter divide ratio and various programmable modes. The divide ratio is put into the Aux_R_CNTR[14:0] field. The divider ratio must be ≥ 2. For the description of bits Aux_R15–Aux_R19 see Section 2.4.

	Most Significant Bit					SHIFT REGISTER BIT LOCATION														Least Significant Bit	
	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	Data Field																				*Address Field*	
Aux_R	FoLD 1	FoLD 0	Aux_CP$_o$_TRI	Aux_CP$_o$_4X	Aux_PD_POL	Aux_R_CNTR[14:0]															0	0
	Aux_R19	Aux_R18	Aux_R17	Aux_R16	Aux_R15	Aux_R14	Aux_R13	Aux_R12	Aux_R11	Aux_R10	Aux_R9	Aux_R8	Aux_R7	Aux_R6	Aux_R5	Aux_R4	Aux_R3	Aux_R2	Aux_R1	Aux_R0		

2.2.2 Main_R Register

If the ADDRESS[1:0] field is set to 1 0, data is transferred from the 22-bit shift register into the Main_R register which sets the Main PLL's 15-bit R-counter divide ratio when Load Enable (LE) signal goes high. The divide ratio is put into the Main_R_CNTR[14:0] field. The divider ratio must be ≥ 2. For the description of bits Main_R15–Main_R19 see Section 2.4.

	Most Significant Bit					SHIFT REGISTER BIT LOCATION														Least Significant Bit	
	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	Data Field																				*Address Field*	
Main_R	FoLD 3	FoLD 2	Main_CP$_o$_TRI	Main_CP$_o$_4X	Main_PD_POL	Main_R_CNTR[14:0]															1	0
	Main_R19	Main_R18	Main_R17	Main_R16	Main_R15	Main_R14	Main_R13	Main_R12	Main_R11	Main_R10	Main_R9	Main_R8	Main_R7	Main_R6	Main_R5	Main_R4	Main_R3	Main_R2	Main_R1	Main_R0		

2.2.3 Reference Divide Ratio (Main and Auxiliary R-Counters)

If the ADDRESS[1:0] field is set to 0 0 or 1 0 (00 for Aux and 10 for Main) data is transferred MSB first from the 22-bit shift register into a latch which sets the respective 15-bit R-counter. Serial data format is shown below.

	Main_R_CNTR[14:0] or Aux_R_CNTR[14:0]														
Divide Ratio	**R14**	**R13**	**R12**	**R11**	**R10**	**R9**	**R8**	**R7**	**R6**	**R5**	**R4**	**R3**	**R2**	**R1**	**R0**
2	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
3	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1
•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•
32,767	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1

Note: R-counter divide ratio must be from 2 to 32,767.

2.3 PROGRAMMABLE FEEDBACK [N] DIVIDERS

2.3.1 Aux_N Register

If the ADDRESS[1:0] field is set to 0 1, data is transferred from the 22-bit shift register into the Aux_N register which sets the Auxiliary PLL's 18-bit N-counter, prescaler value and power-down bit. The 18-bit N-counter consists of a 5-bit swallow counter, Aux_A_CNTR[4:0], and a 13-bit programmable counter, Aux_B_CNTR[12:0]. Serial data format is shown below.

2.0 Programming Description (Continued)

	Most Significant Bit																				Least Significant Bit	
	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	Data Field																				*Address Field*	
Aux_N	Aux_PWDN	P_Aux	Aux_B_CNTR[12:0]													Aux_A_CNTR[4:0]					0	1
	Aux_N19	Aux_N18	Aux_N17	Aux_N16	Aux_N15	Aux_N14	Aux_N13	Aux_N12	Aux_N11	Aux_N10	Aux_N9	Aux_N8	Aux_N7	Aux_N6	Aux_N5	Aux_N4	Aux_N3	Aux_N2	Aux_N1	Aux_N0		

2.3.2 Main_N Register

If the ADDRESS[1:0] field is set to 1 1, data is transferred from the 22-bit shift register into the Main_N register which sets the Main PLL's 18-bit N-counter, prescaler value and power-down bit. The 18-bit N-counter consists of a 5-bit swallow counter, Main_A_CNTR[4:0], and a 13-bit programmable counter, Main_B_CNTR[12:0]. Serial data format is shown below.

	Most Significant Bit																				Least Significant Bit	
	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	Data Field																				*Address Field*	
Main_N	Main_PWDN	P_Main	Main_B_CNTR[12:0]													Main_A_CNTR[4:0]					1	1
	Main_N19	Main_N18	Main_N17	Main_N16	Main_N15	Main_N14	Main_N13	Main_N12	Main_N11	Main_N10	Main_N9	Main_N8	Main_N7	Main_N6	Main_N5	Main_N4	Main_N3	Main_N2	Main_N1	Main_N0		

2.3.3 Feedback Divide Ratio (Main B Counter, Auxiliary B Counter)

	Main_B_CNTR[12:0] or Aux_B_CNTR[12:0]												
Divide Ratio	**N17**	**N16**	**N15**	**N14**	**N13**	**N12**	**N11**	**N10**	**N9**	**N8**	**N7**	**N6**	**N5**
3	0	0	0	0	0	0	0	0	0	0	0	1	1
4	0	0	0	0	0	0	0	0	0	0	1	0	1
•	•	•	•	•	•	•	•	•	•	•	•	•	•
8,191	1	1	1	1	1	1	1	1	1	1	1	1	1

Note: B-counter divide ratio must be ≥ 3.

2.3.4 Swallow Counter Divide Ratio (Main A Counter, Auxiliary A Counter)

	Main_A_CNTR[4:0] or Aux_A_CNTR[4:0]				
Divide Ratio	**Main_N4**	**Main_N3**	**Main_N2**	**Main_N1**	**Main_N0**
0	0	0	0	0	0
1	0	0	0	0	1
•	•	•	•	•	•
31	1	1	1	1	1

Notes: A < P, B > A.

2.0 Programming Description (Continued)

2.3.5 PLL Prescaler Select (P_Aux, P_Main)

The LMX2370, LMX2371 and LMX2372 contain two dual modulus prescalers. A 32/33 or a 16/17 prescaler can be selected for the 2.5 GHz and 2.0 GHz RF synthesizers in the LMX2370 and LMX2371 respectively. The 16/17 prescaler is only rated for input frequencies below 1.2 GHz. A 16/17 or an 8/9 prescaler can be selected for the both 1.2 GHz synthesizers on the LMX2372 as well as the 1.2 GHz synthesizers on the LMX2370 and LMX2371. The 8/9 prescaler is only rated for input frequencies below 550 MHz.

	Prescaler Value		
P_Main, (Main_N18) or P_Aux (Aux_N18)	**2.5 GHz PLL**	**2.0 GHz PLL**	**1.2 GHz PLL**
0	16/17	16/17	8/9
1	32/33	32/33	16/17

	Allowable Prescaler Values		
PLL Input Frequency	**2.5 GHz PLL**	**2.0 GHz PLL**	**1.2 GHz PLL**
f_{IN} > 1.2 GHz	32/33	32/33	NA
550 < f_{IN} < 1200 MHz	16/17 or 32/33	16/17 or 32/33	16/17
f_{IN} < 550 MHz	16/17 or 32/33	16/17 or 32/33	8/9 or 16/17

2.3.5.1 Pulse Swallow Function

$f_{VCO} = [(P \times B) + A] \times f_{OSC}/R$

f_{VCO}: Output frequency of external voltage controlled oscillator (VCO)

B: Preset divide ratio of binary 13-bit programmable counter (3 to 8191)

A: Preset divide ratio of binary 5-bit swallow counter

$0 \le A \le 31$ {P=32}

$0 \le A \le 15$ {P=16}

$0 \le A \le 7$ {P=8}

$A \le B$

f_{OSC}: Output frequency of the external reference frequency oscillator

R: Preset divide ratio of binary 15-bit programmable reference counter (3 to 32767)

P: Preset modulus of dual modulus prescaler (P = 8, 16, or 32)

2.3.6 PLL Power Down Control (Aux_PWDN, Main_PWDN)

The **Aux_PWDN (Aux_N19)** and **Main_PWDN (Main_N19**) bits are used to power down either the Main or Auxiliary PLL's charge pump portion, or the entire PLL block depending on the setting of the respective charge pump TRI-STATE bit (Aux_CP_o_TRI or Main_CP_o_TRI) in the R_CNTR register. The power-down mechanism is described below. The R and N counters for each respective PLL are disabled and held at reset during the synchronous and asynchronous power down modes. This will allow a smooth acquisition of the Main RF signal when the oscillator input buffer is still active (Auxiliary loop powered up) and vice versa. Upon powering up, both R and N counters will start at the "zero" state, and the relationship between R and N will not be random.

Synchronous Power Down Mode

One of the PLL loops can be synchronously powered down by first setting the respective loop's TRI-STATE mode bit LOW (R17 = 0) and then asserting its power down mode bit (N19 = 1). The power down function is gated by the charge pump. Once the power down program bits Aux_PWDN (Aux_N19) and Main_PWDN (Main_N19) and TRI-STATE bits Aux_CP_o_TRI (Aux_R17) or Main_CP_o_TRI (Main_R17) are loaded, the part will go into power down mode upon the completion of a charge pump pulse event.

Asynchronous Power Down Mode

One of the PLL loops can be asynchronously powered down by first setting the respective loop's TRI-STATE mode bit HI (R17 = 1) and then asserting its power down mode bit (N19 = 1). The power down function is NOT gated by the charge pump. Once the power down program bits Aux_PWDN (Aux_N19) and Main_PWDN (Main_N19) and its respective TRI-STATE bit Aux_CP_o-_TRI (Aux_R17) or Main_CP_o_TRI (Main_R17) are loaded, the part will go into power down mode immediately.

2.0 Programming Description (Continued)

2.3.7 Power Down Mode Table

Main PLL	Auxiliary PLL	Main Counters	Auxiliary Counters	OSC_{in} Buffer
Active	Active	ON	ON	ON
Active	Powered Down	ON	OFF	ON
Powered Down	Active	OFF	ON	ON
Powered Down	Powered Down	OFF	OFF	OFF

2.4 PROGRAMMABLE MODES

Several modes of operation can be programmed with bits R15–R19 including the phase detector polarity, charge pump magnitude, charge pump TRI-STATE and the output of the Fo/LD pin. The programmable modes are shown in Table 1. Truth table for the programmable modes and Fo/LD output are shown in Table 2 and Table 3.

2.4.1 Programmable Modes Table

R19	R18	R17	R16	R15	Address[1:0]
f_{OUT}/Lock Detect		Charge Pump TRI-STATE	Charge Pump Magnitude	Phase Detector Polarity	
FoLD 1	FoLD 0	Aux_CP_o_TRI	Aux_CP_o_4X	Aux_PD_POL	0 0
FoLD 3	FoLD 2	Main_CP_o_TRI	Main_CP_o_4X	Main_PD_POL	1 0

2.4.2 Mode Select Truth Table

	CP_o_TRI (Note 6)	**CP_o_4X** (Note 7)	**PD_POL** (Note 8)
0	Normal Operation	1X Current	LOW
1	TRI-STATE	4X Current	HIGH

Note 6: Both synchronous and asynchronous power down modes are available with the LMX237X family to be able to adapt to different types of applications. The MICROWIRE control register remains active and capable of loading and latching in data during all of the powerdown modes.

Note 7: ICP_o (charge pump current magnitude) is dependent on Vp. The ICP_o LOW current state = 1/4 x ICP_o HIGH current.

Note 8: See Section 2.4.3

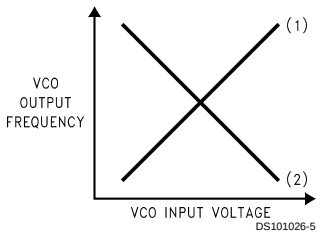
2.4.3 Phase Detector Polarity (Aux_PD_POL, Main_PD_POL)

Depending upon VCO characteristics, the Aux_PD_POL (Aux_R15) and Main_PD_POL (Main_R15) bits should be set accordingly:

When VCO characteristics are positive like (1), R15 should be set HIGH;

When VCO characteristics are negative like (2), R15 should be set LOW.

VCO CHARACTERISTICS



2.0 Programming Description (Continued)

2.4.4 The FoLD Output Truth Table

Main R[18]	Aux R[18]	Main R[19]	Aux R[19]	Fo/LD Output State
0	0	0	0	Disabled
0	1	0	0	Aux Lock Detect (Note 9)
1	0	0	0	Main Lock Detect (Note 9)
1	1	0	0	Main/Aux Lock Detect (Note 9)
X	0	0	1	Aux Reference Divider Output
X	0	1	0	Main Reference Divider Output
X	1	0	1	Aux Programmable Divider Output
X	1	1	0	Main Programmable Divider Output
0	0	1	1	FastLock Output. Open Drain Output (Note 10)
0	1	1	1	Reset Aux R and N Counters and TRI-STATE Aux Charge Pump (Note 11)
1	0	1	1	Reset Main R and N Counters and TRI-STATE Main Charge Pump (Note 11)
1	1	1	1	Reset All Four Counters and TRI-STATE both Charge Pumps (Note 11)

X - don't care condition

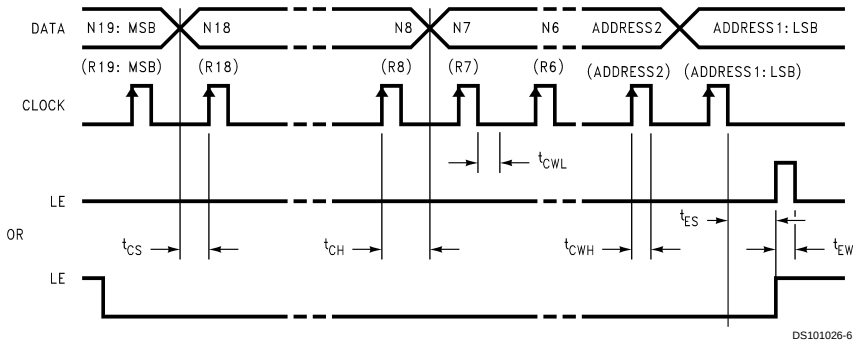
Note 9: Open drain lock detect output is provided to indicate when the VCO frequency is in "lock". When the loop is locked and a lock detect mode is selected, the pin is HIGH, with narrow pulses LOW. In the Main/Aux lock detect mode a locked condition is indicated when Main and Aux are both locked.

Note 10: The FastLock mode utilizes the FoLD output pin to switch a second loop filter damping resistor to ground during FastLock operation. Activation of FastLock occurs whenever the Main loop's ICP_o magnitude bit R[16] is selected HI while the R[18] and R[19] mode bits are set.

Note 11: Aux and Main PLLs can be reset independently from each other by using the R[18] and R[19] bits. The Aux Counter Reset mode resets Aux PLL's R and N counters and brings Aux charge pump output to TRI-STATE condition. The Main Counter Reset mode resets Main PLL's R and N counters and brings Main charge pump output to a TRI-STATE condition. The Aux and Main Counter Reset modes reset all counters and bring both charge pump outputs to a TRI-STATE condition. Upon removal of the Reset bits, the N counter resumes counting in "close" alignment with the R counter. (The maximum error is one prescaler cycle.)

2.5 Serial Data Input Timing

Serial Data Input Timing



NOTES: Parenthesis data indicates programmable reference divider data.

Data shifted into register on clock rising edge.

Data is shifted in MSB first.

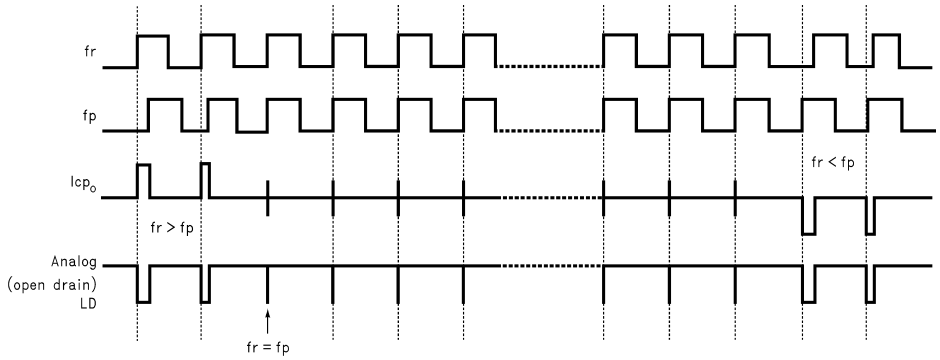
TEST CONDITIONS: The Serial Data Input Timing is tested using a symmetrical waveform around $V_{CC}/2$. The test waveform has an edge rate of 0.6 V/ns with amplitudes of 2.2V @ V_{CC} = 2.7V and 2.6V @ V_{CC} = 5.5V.

2.0 Programming Description

(Continued)

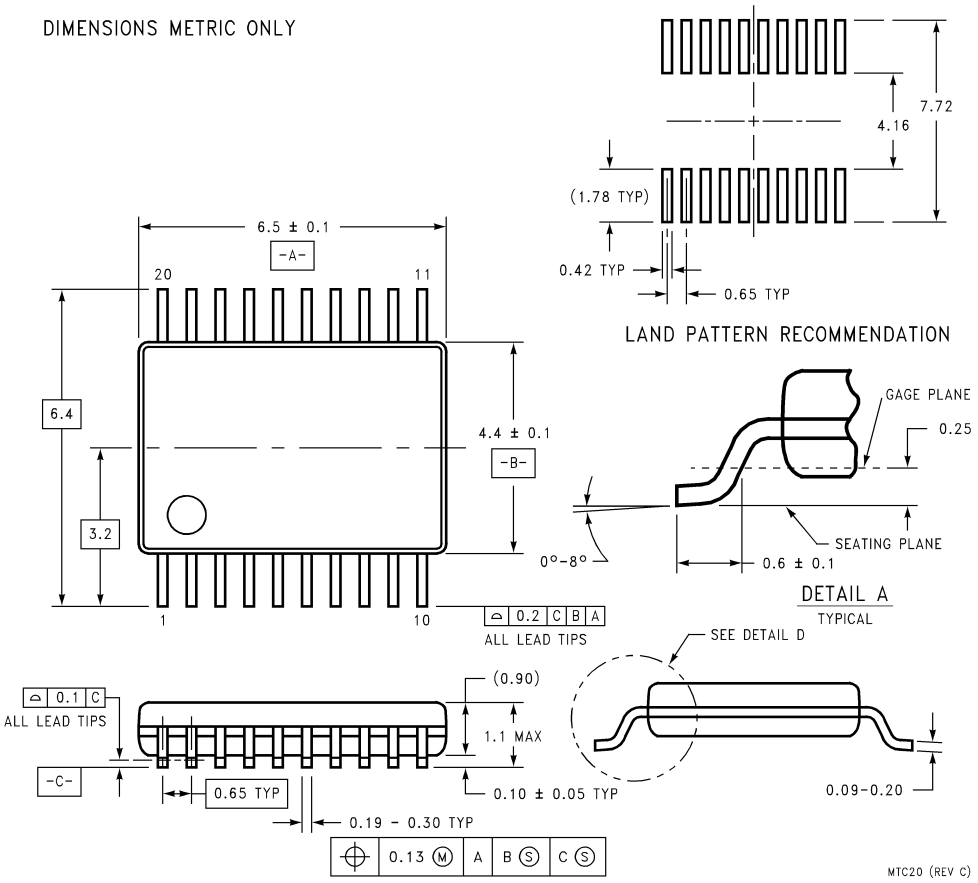
2.6 Typical Lock Detect Timing

Typical Lock Detect Timing



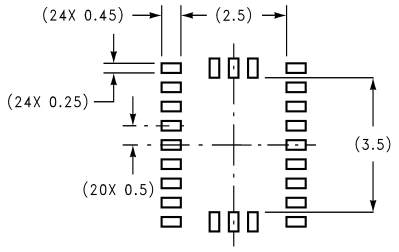
DS101026-7

Physical Dimensions inches (millimeters) unless otherwise noted



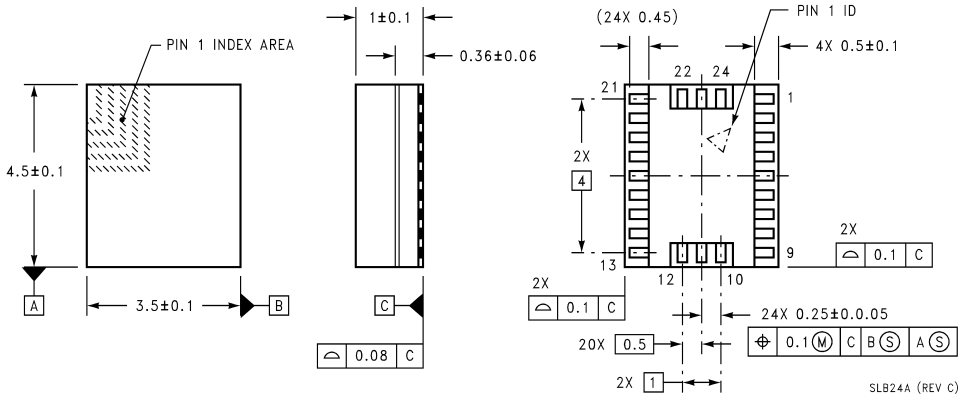
Thin Shrink Small Outline (TSSOP) Package
Order Number LMX2370TM, LMX2371TM or LMX2372TM
***For Tape and Reel (2500 units per reel)**
Order Number LMX2370TMX, LMX2371TMX or LMX2372TMX
NS Package Number MTC20

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



DIMENSIONS ARE IN MILLIMETERS

RECOMMENDED LAND PATTERN
1:1 RATIO WITH PACKAGE SOLDER PADS



Chip Scale Package
For Tape and Reel (2500 Units Per Reel)
Order Numbers: LMX2370SLBX, LMX2371SLBX, LMX2372SLBX
NS Package Number SLB24A

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